Supplementary Information

Mechanistic insights of the key role of methylammonium iodide in the stability of perovskite material

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Table S1: History of studies related to MAI

		PbI_2/MAI	Additive	Condition	Ref.	Year
Methylammonium iodide	Precursor	1, 1	$H_2O_{(Trace)}$	$MAI_{Assay}(H_4P_2O_6)$ dipping	1, 2 3	2016-2017-2016
		1,1, 1	HI, CH_3I	$MAI_{loading\ time,\ co\text{-}evaporation}$	2, 4 5	2016-2015-2016
		1/3	DMSO	$MAI_{Vapor\text{-}based}$	6 7	2021-2020
		1		$MAI_{Purity,Vapor\text{-}Phase}$	8	2022
		1		$PbI_{2powder}$+MAI	9	2016
		1/4		Precursor $_{Temperature,\ one\ step}$	10	2021
		1/2, 1/3, 1/5		$MAI_{time\ of\ dipping}$	11	2018
		1		MAI-based $_{co\text{-}evaporation}$	12	2019
		1		MAI $_{aged}$	13	2021
		1		MAI $_{co\text{-}evaporation}$	14	2016
		-		Computational details	15	2019
		1		PbIx:MAAc:MAI	16	2017
		1		BAI:MAI:PbI_2:NH_4SCN	17	2017
		1		Synchrotron source	18	2022
		1		Thermal co-evaporation	2	2016
		1		Phase diagram $_{one\ step}$	19	2017
	Post-syn	10%	MAI_{excess}+ $CsPbI_2Br$		20	2020
		-10% to 10%		$MAI_{extra\text{-}stoichiometric}$	21	2019
		(10,30)mM		MAI $_{post\text{-}treatment}$	22 23	2019-2022
		Partial pressure		MSGG	24	2021

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